## DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name and I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE CAPABLE OF ETCHING A MULTI-LAYER OF ORGANIC FILMS AT A HIGH SELECTIVITY the specification of which (check one)

(x) is attached hereto: ( ) was filed on	as United States Applica	ation Number or PCT International	Application Number	
on, and was amended	d on (1f a	applicable).		
I hereby state that I have reviewed and und amendment referred to above. I acknowled Federal Regulation, §1.56. I hereby claim for patent or inventor's certificate listed bel disclosing the subject matter claimed in the or (2) if no priority is claimed, before the f	dge the duty to disclose infor foreign priority benefits und low and have also identified eir application and having a t	mation which is material to patent ler Title 35, United States Code, §1 below any foreign application for filing date (1) before that of the ap	ability as defined in T 19/365 of any foreign patent or inventor's ce	Title 37, Code of a application(s) entificate
·	Prior foreign	1 A vpiication(s)		
Number	Country	Day/Month/Year Filed	Priority Claimed	
047358/2001	Japan	22/2/2001	(X) Yes () N	io
			( ) Yes ( ) N	lo
			() Yes () N	Ía
States application in the manner provided information which is material to patentabil filing date of the prior application and the	lity as defined in Title 37, Conational or PCT international	ode of Federal Regulations, §1 56 liftling date of this application.	which became availab	to discusse the between the
(Application Number) Day/N	Month/Year Filed	Status (Patented, Pending, Abar	ndoned)	
I hereby appoint Donald W. Muirhead, Re prosecute this application and to transact a Address all telephone calls to Donald W.	all business in the Patent and	Tra: e.nark Office connected there	ewith.	59 as attomeys to
nu Bung.	Patent Gro	oup Wheeler & Dittmar		
e duning de	101 Federa Boston, M	al Street		
I hereby declare that all statements made a believed to be true; and further that these punishable by fine or imprisonment, or bo jeopardize the validity of the application of	statements were made with t oth, under Section 1001 of Ti	he knowledge that willful false sta	tements and the like s	o made are
Inventor's signature Hiroto	Ohtoke (	杏	Date February	21,2002
Full name of sole or first inventor (given r	name, family name) <u>Hir</u>	coto OHTAKE		
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(X) Additional inventors are being named on separately numbered sheets attached hereto

## DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION (continued)

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Inventor's signature Johnico Yanas Vashihira HAYASHI	Date February 21,2002
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•	
Inventor's signature	Date
Full name of fifth inventor (given name, family name)  Residence	
Post office Address (include zip code)  Inventor's signature  Full hame of sixth inventor (given name, family name)	Date
Residence	Citizenship
Post Office Address (include zip code)  Inventor's signature  Falliname of seventh inventor (given name, family name)	Date
Residence	Citizenship
Post Office Address (include zip code)	
Inventor's signature	
Full name of eighth inventor (given name, family name)	
Residence	Citizenship
Post Office Address (include zip code)	